

AMENDMENTS TO THE SPECIFICATION

Please amend Paragraphs [0002] and [0011] of the specification as follows:

[0002] This application is also related to (a) copending Application Serial No. 10/064,389, filed July 9, 2002 (Publication No. 2003/0025855, now U.S. Patent No. 6,831,769), which itself claims benefit of Provisional Application Serial No. 60/304,117, filed July 9, 2001; (b) copending Application Serial No. 10/249,957, filed May 22, 2003 (Publication No. ~~2004/0027326~~2004/0027327), which itself claims benefit of Provisional Application Serial No. 60/319,300, filed June 10, 2002, and Provisional Application Serial No. 60/320,186, filed May 12, 2003; and (c) copending Application Serial No. 10/605,024, filed September 2, 2003 (Publication No. 2004/0155857), which itself claims benefit of Provisional Application Serial No. 60/319,516, filed September 2, 2002.

[0011] Numerous patents and applications assigned to or in the names of the Massachusetts Institute of Technology (MIT) and E Ink Corporation have recently been published describing encapsulated electrophoretic media. Such encapsulated media comprise numerous small capsules, each of which itself comprises an internal phase containing electrophoretically-mobile particles suspended in a liquid suspension medium, and a capsule wall surrounding the internal phase. Typically, the capsules are themselves held within a polymeric binder to form a coherent layer positioned between two electrodes. Encapsulated media of this type are described, for example, in U.S. Patents Nos. 5,930,026; 5,961,804; 6,017,584; 6,067,185; 6,118,426; 6,120,588; 6,120,839; 6,124,851; 6,130,773; 6,130,774; 6,172,798; 6,177,921; 6,232,950; ~~[[6,249,721]]~~6,249,271; 6,252,564; 6,262,706; 6,262,833; 6,300,932; 6,312,304; 6,312,971; 6,323,989; 6,327,072; 6,376,828; 6,377,387; 6,392,785; 6,392,786; 6,413,790; 6,422,687; 6,445,374; 6,445,489; 6,459,418; 6,473,072; 6,480,182; 6,498,114; 6,504,524; 6,506,438; 6,512,354; 6,515,649; 6,518,949; 6,521,489; 6,531,997; 6,535,197; 6,538,801; 6,545,291; 6,580,545; 6,639,578; 6,652,075; 6,657,772; 6,664,944; 6,680,725; 6,683,333; and 6,704,133; and U.S. patent applications Publication Nos. 2002/0019081;

2002/0021270; 2002/0053900; 2002/0060321; 2002/0063661; 2002/0063677;
2002/0090980; 2002/0106847; 2002/0113770; 2002/0130832; 2002/0131147;
2002/0145792; 2002/0171910; 2002/0180687; 2002/0180688; 2002/0185378;
2003/0011560; 2003/0011868; 2003/0020844; 2003/0025855; 2003/0034949;
2003/0038755; 2003/0053189; 2003/0096113; 2003/0102858; 2003/0132908;
2003/0137521; 2003/0137717; 2003/0151702; 2003/0189749; 2003/0214695;
2003/0214697; 2003/0222315; 2004/0008398; 2004/0012839; 2004/0014265; and
2004/0027327; and International Applications Publication Nos. WO 99/67678; WO
00/05704; WO 00/38000; WO 00/38001; WO00/36560; WO 00/67110; WO 00/67327;
WO 01/07961; WO 01/08241; WO 03/092077; and WO 03/107,315.